

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT										
NATURE OF CONVEYANCE:	Corrective Assignment to correct the error in not including Liang-Choo Hsia and to correct doc date for Gek Soon Chua. previously recorded on Reel 016664 Frame 0946. Assignor(s) hereby confirms the Assignment.										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sia Kim Tan</td> <td>09/28/2005</td> </tr> <tr> <td>Qunying Lin</td> <td>09/28/2005</td> </tr> <tr> <td>Gek Soon Chua</td> <td>09/28/2005</td> </tr> <tr> <td>Liang-Choo Hsia</td> <td>10/11/2005</td> </tr> </tbody> </table>		Name	Execution Date	Sia Kim Tan	09/28/2005	Qunying Lin	09/28/2005	Gek Soon Chua	09/28/2005	Liang-Choo Hsia	10/11/2005
Name	Execution Date										
Sia Kim Tan	09/28/2005										
Qunying Lin	09/28/2005										
Gek Soon Chua	09/28/2005										
Liang-Choo Hsia	10/11/2005										
RECEIVING PARTY DATA											
Name:	CHARTERED SEMICONDUCTOR MANUFACTURING LTD.										
Street Address:	60 Woodlands Industrial Park D										
Internal Address:	Street 2										
City:	Singapore 738406										
State/Country:	SINGAPORE										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11163481</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11163481						
Property Type	Number										
Application Number:	11163481										
CORRESPONDENCE DATA											
Fax Number:	(408)738-0881										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	408-738-0592										
Email:	efiling@ishimarulaw.com										
Correspondent Name:	Mikio Ishimaru										
Address Line 1:	Law Offices of Mikio Ishimaru										
Address Line 2:	333 W. El Camino Real, Suite # 330										
Address Line 4:	Sunnyvale, CALIFORNIA 94087										
ATTORNEY DOCKET NUMBER:	1016-055										
NAME OF SUBMITTER:	Mikio Ishimaru										

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500831657

PATENT
REEL: 022530 FRAME: 0317

Total Attachments: 8

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PATENT ASSIGNMENT

Electronic Version v08
 Stylesheet Version v02

10/20/2005
 800021693

SUBMISSION TYPE:		NEW ASSIGNMENT	APPLICATION NUMBER 11/163481		
NATURE OF CONVEYANCE:		ASSIGNMENT OF ASSIGNOR'S INTEREST			
CONVEYING PARTY DATA					
Name		Execution Date			
Sia Kim Tan		2005-09-28			
Qunying Lin		2005-09-28			
Gek Soon Chua		2005-10-11			
RECEIVING PARTY DATA					
Name	Street Address	Internal Address	City	State/Country	Postal Code
Chartered Semiconductor Manufacturing Ltd.	60 Woodlands Industrial Park D, Street 2		Singapore	SINGAPORE	738406
CORRESPONDENCE DATA					
FAX NUMBER: 4087380881					
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>					
When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.					
CUSTOMER NUMBER: 022898					
NAME OF PERSON SIGNING:		Mikio Ishimaru			
DATE SIGNED:		2005-10-20			
Total Attachments: 5 source=1016-055assign1a.tif source=1016-055assign2a.tif source=1016-055assign3a.tif source=1016-055assign4a.tif source=1016-055assign5a.tif					

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ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

POLARIZING PHOTOLITHOGRAPHY SYSTEM

for which a United States patent application has been executed on or before the date of this assignment.

WHEREAS, CHARTERED SEMICONDUCTOR MANUFACTURING LTD., a Corporation of the Republic of Singapore, having a place of business at 60 Woodlands Industrial Park D, Street 2, Singapore 738406, Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries.

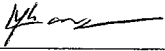
NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



Sia Kim Tan



Witness Signature

YEO KWEE LIANG

Print Witness Name

28/09/05

Date

28 SEP 2005

Date



Witness Signature

ALLIA WONG

Print Witness Name

28/09/05

Date

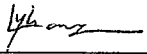
IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



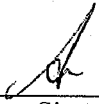
Qunying Lin

28/9/05

Date



Witness Signature



Witness Signature

YEO KWEE LIANG

Print Witness Name

ALLEN WONG

Print Witness Name

28/09/05

Date

28/9/05

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Gek Soon Chua
Gek Soon Chua

28/9/2005
Date

[Signature]
Witness Signature

[Signature]
Witness Signature

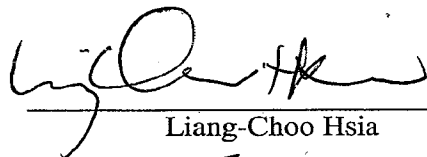
YEOW KWEE LIANG
Print Witness Name

ALICIA WONG
Print Witness Name

28/09/05
Date

28/9/05
Date

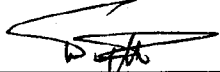
IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



Liang-Choo Hsia

11 OCT '05

_____ Date



Witness Signature



Witness Signature

SHAN WONG

_____ Print Witness Name

ALICIA WONG

_____ Print Witness Name

11 OCT '05

_____ Date

11/10/05

_____ Date